

2nd Annual Solid State Energy Conversion Alliance (SECA) Workshop

Low Cost Multi-layer Fabrication Method for Solid Oxide Fuel Cells

DE-AC26-00NT40707

Dr. Christopher Milliken

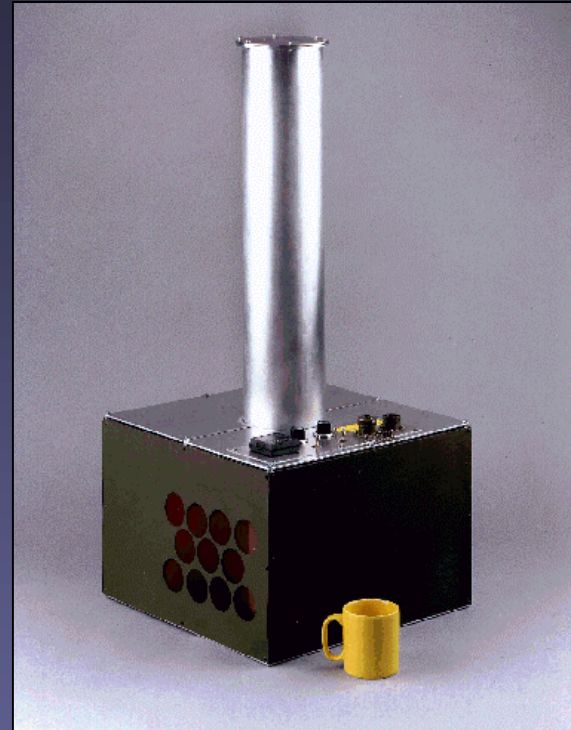
Technology Management, Inc.

Cleveland, Ohio tmi@stratos.net

Tom George, NETL Project Manager

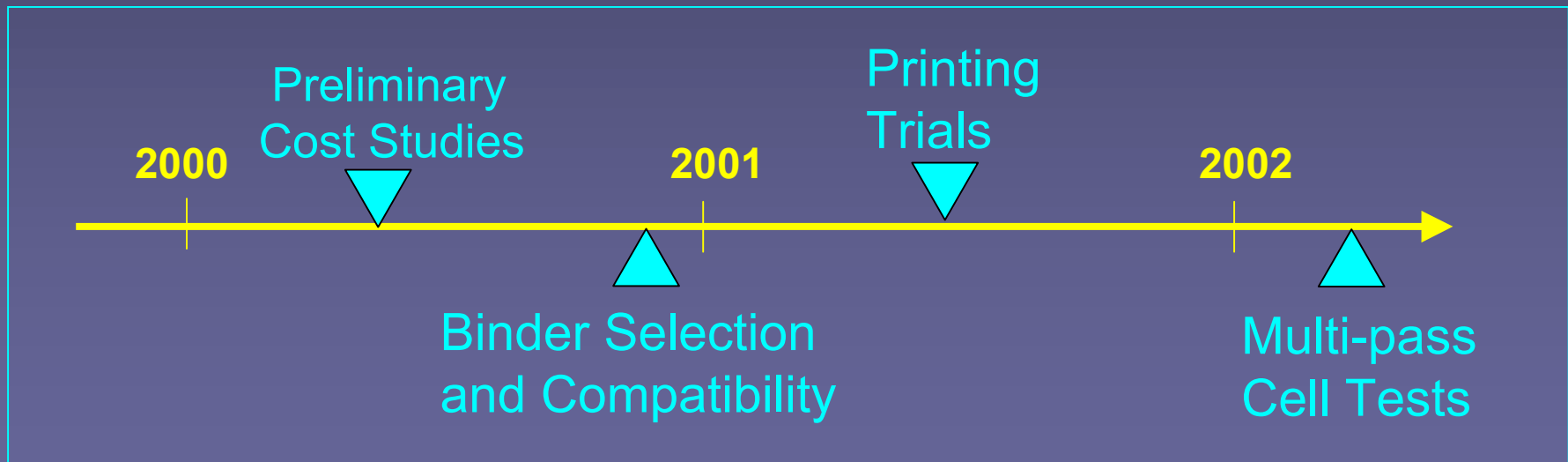
Background of TMI

- Organized in 1990 to commercialize low cost planar SOFC technology
- Engineered compact, integrated, systems.
- Designed for multi-use applications and simplified field service.
- Operated on common fuels- multiple 100 Cell stacks on CH₄ /JP-8



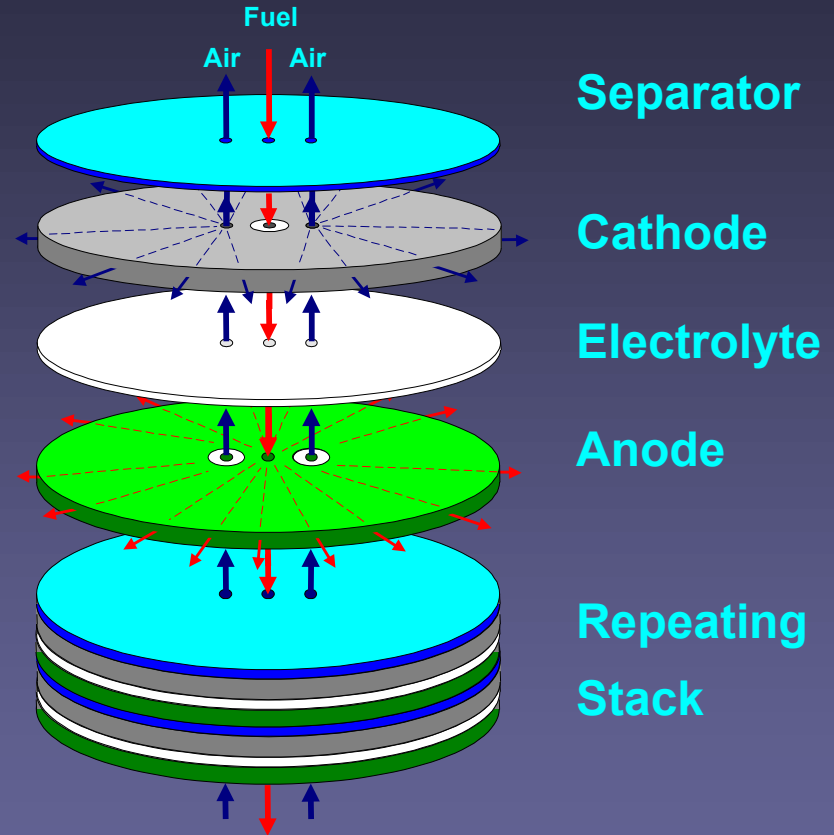
Overall Program Objectives

- *Large demand for low cost SOFC systems.*
- *Multi-Pass Screen Printing* -mature, low cost fabrication technique adapted to the TMI SOFC radial-flow design



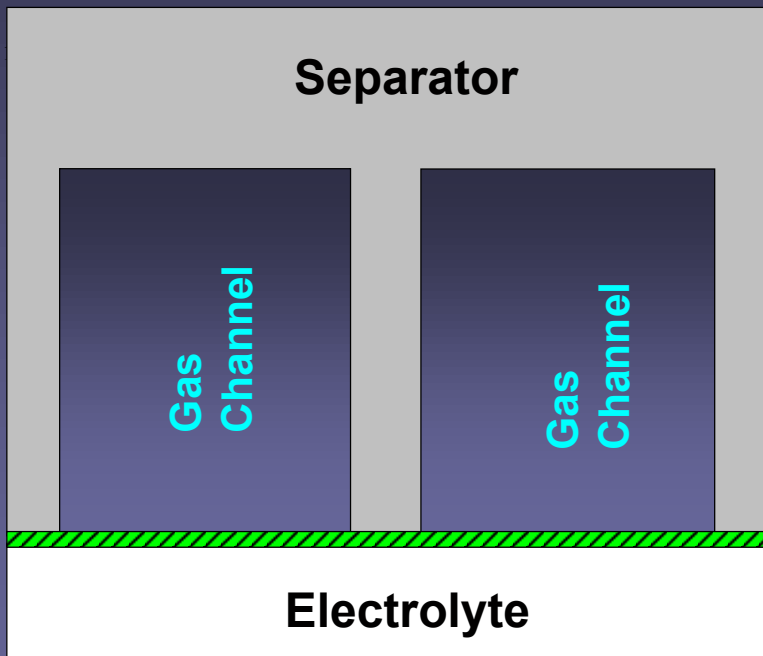
TMI Cell Design

- Simple Geometry
- Small, central seals
- Radial Co-flow
- Low Cost (vs. Performance)

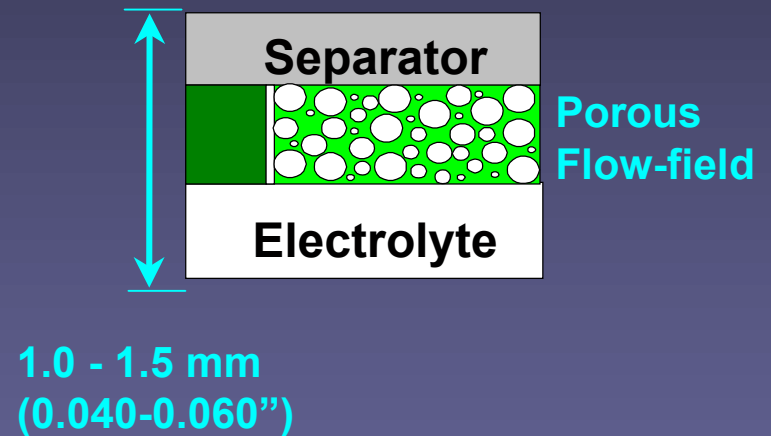


Compatible Flow Strategy

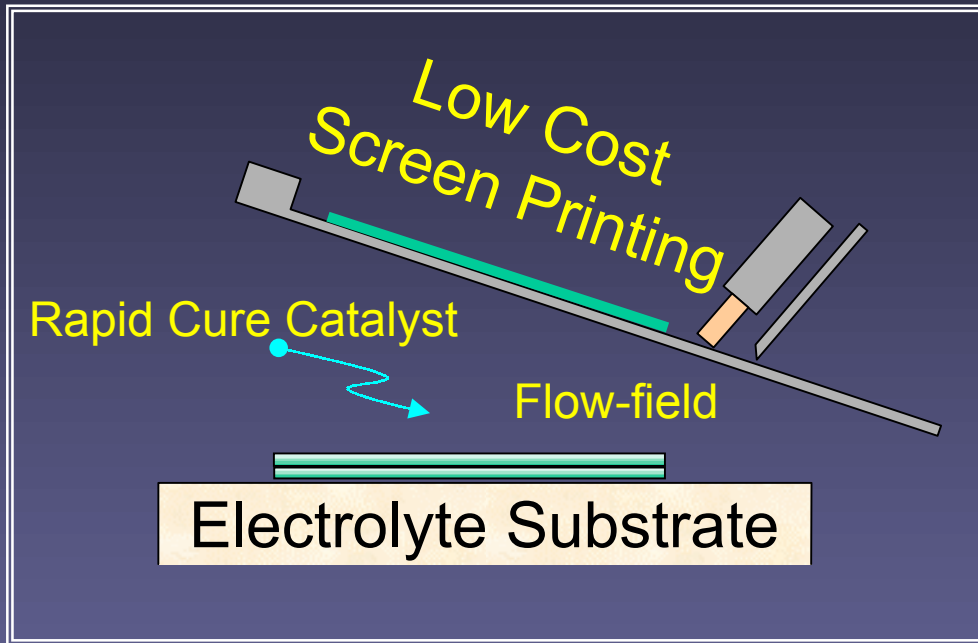
A Common Planar Design



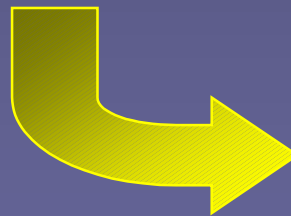
TMI Design



Low Cost Manufacturing Strategy



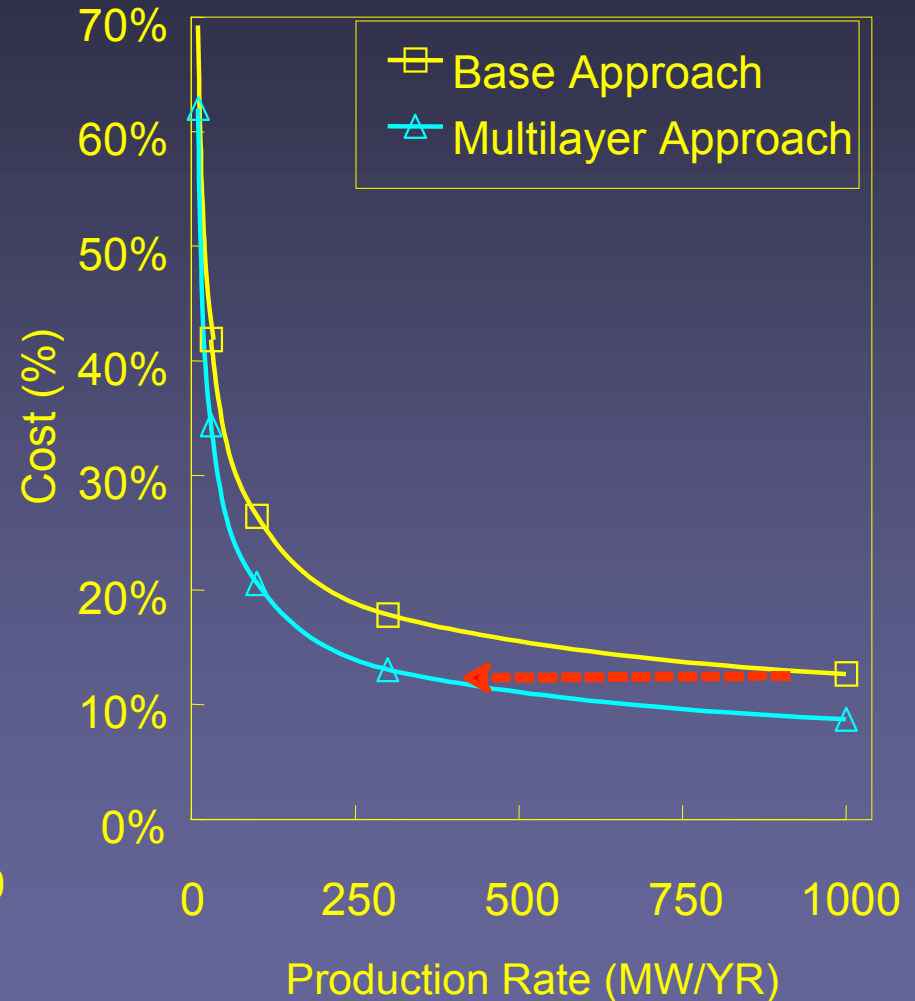
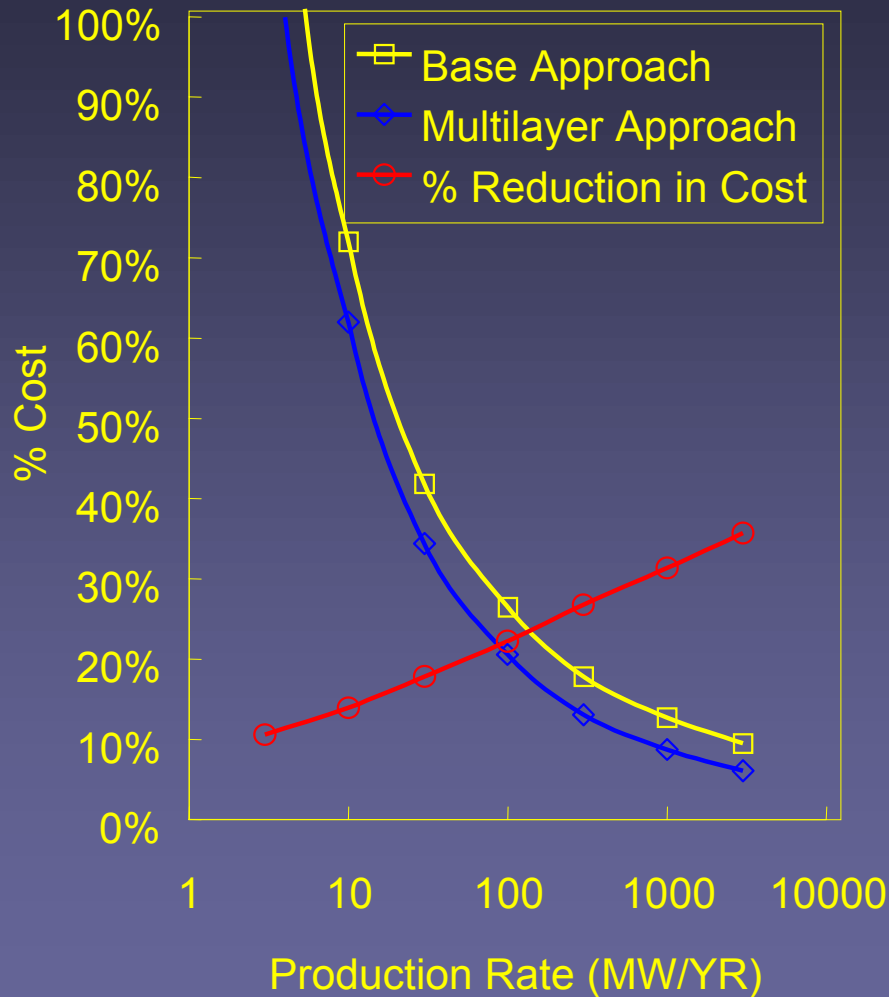
Automated Commercial Screen Printer



Task 1. Cost/Benefit Estimate

- Cost Build-up:
 - Direct Materials, Labor and Overhead
 - Indirect
 - Amortization of Capital Costs
- Benefits
 - Reduced Stack Cost
 - Increased Power Density (volume and weight)

Lower Per-Unit Costs



Task 2. Binder Systems

- Identified Candidate Binders
- Characterized Seven different systems
 - Reactivity/Contamination
 - Sensitivity/Hardness
- Four systems ranked by Compatibility.

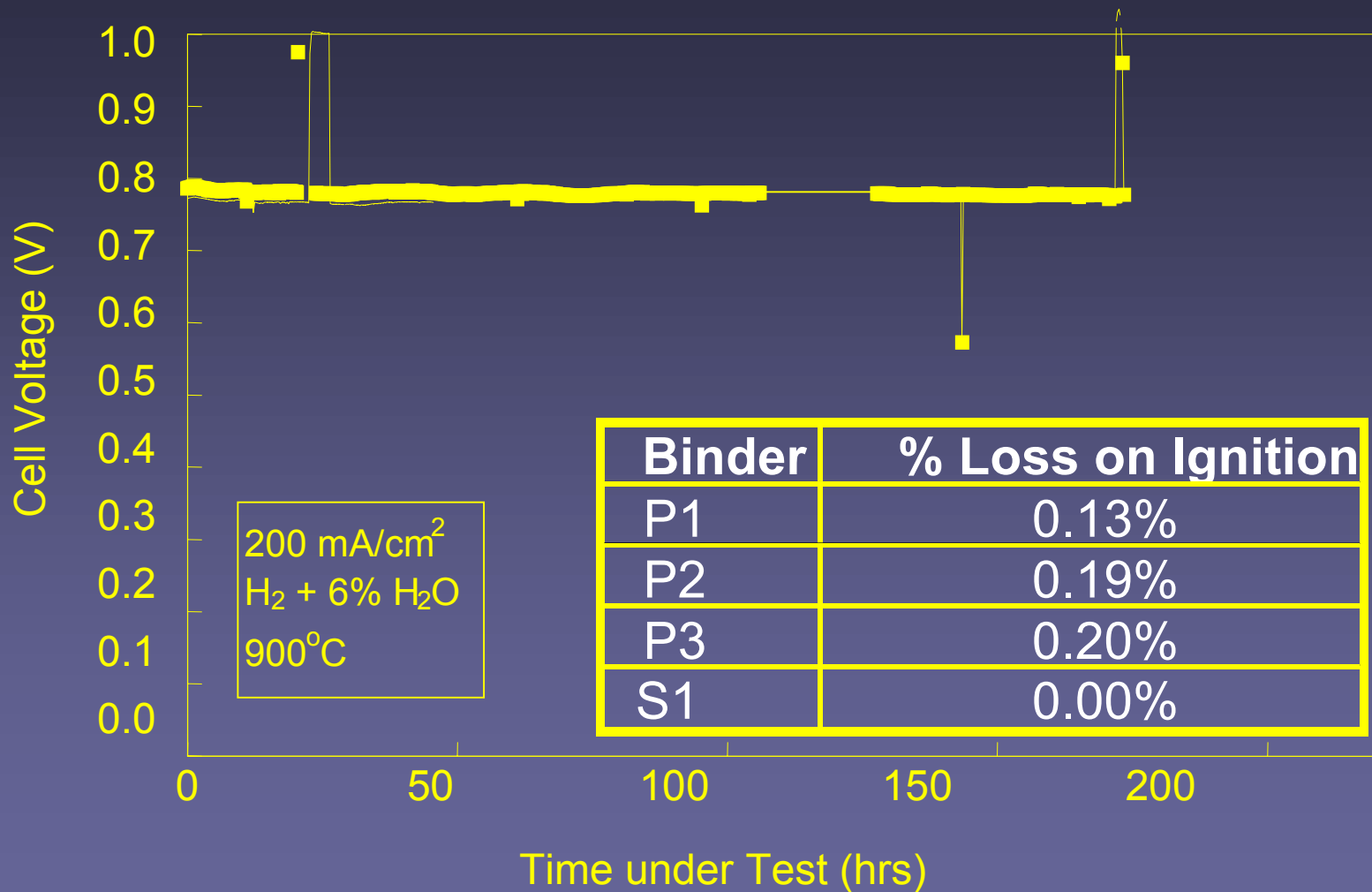
Reactivity Analysis

Binder	Cathode Powder	Seal Glass	Anode Powder
<i>Sample S1*</i>	None	None	None
Sample C1**	None	None	None
Sample C2	None	None	None
<i>Sample P1</i>	None	None	None
<i>Sample P2</i>	None	None	None
<i>Sample P3</i>	None	None	None
Sample P4	Slight	Slight	Slight

* Reacted > 24 hrs with Cathode

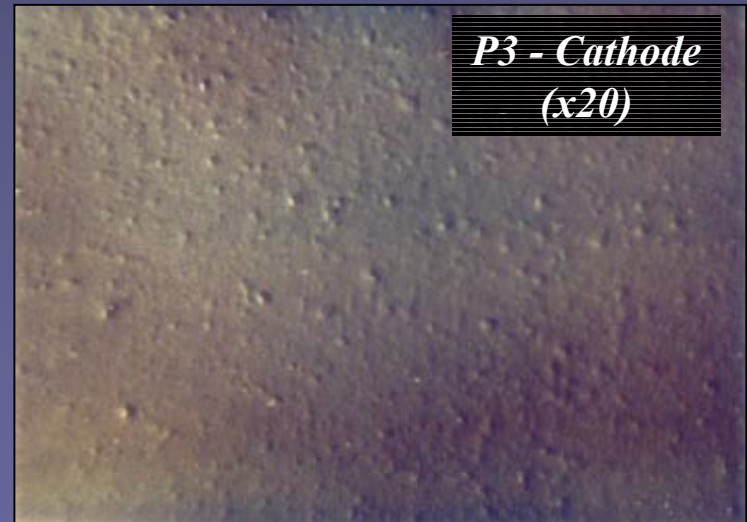
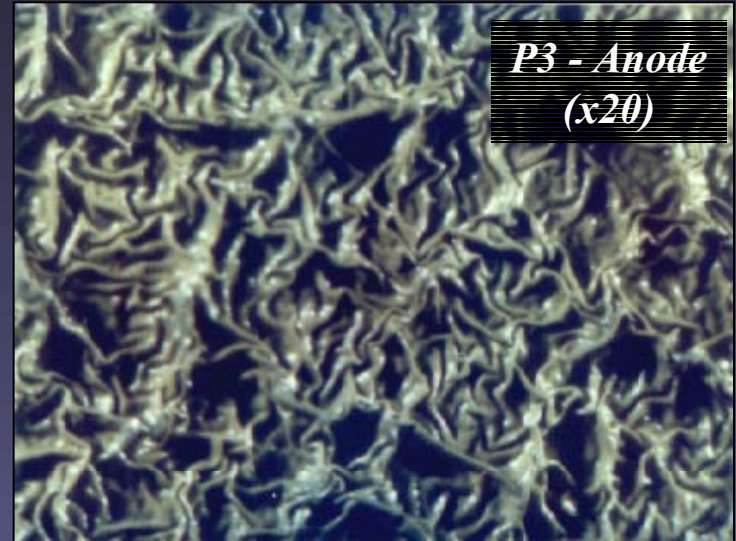
** Reacts in ambient conditions

Cell Performance (a Contamination Indicator)



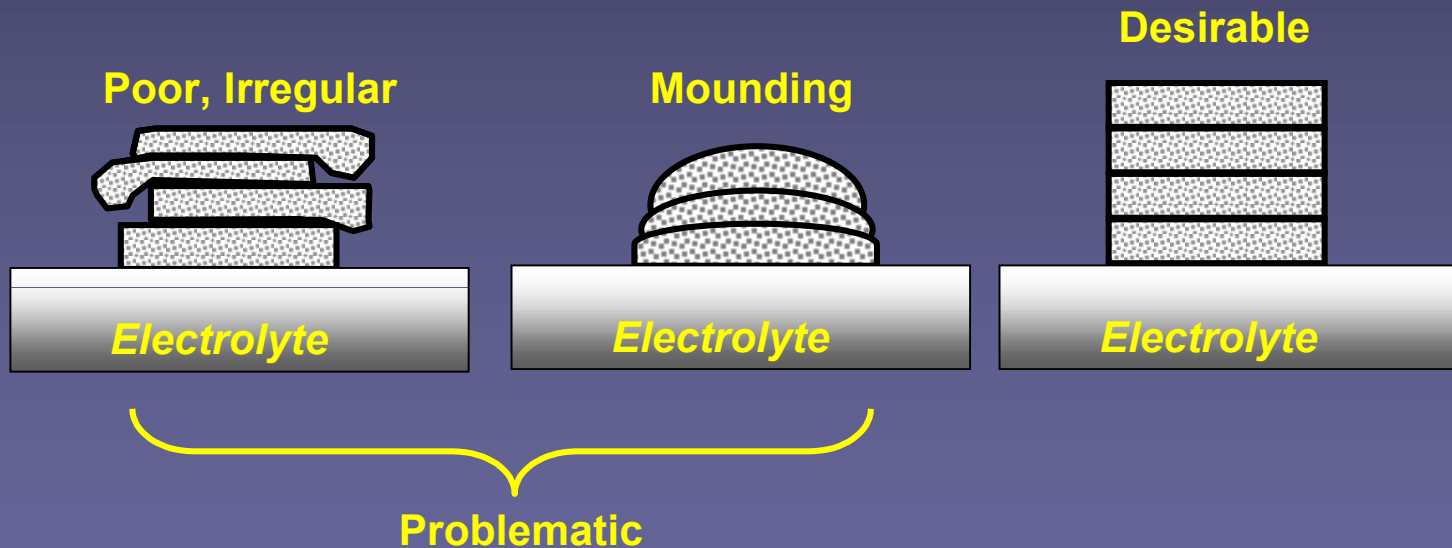
Task 3. Ink Curing Quality

- Curing quality & rate depends on powder, thickness, and catalyst
- Challenges
 - Voids / Pockets
 - Incomplete curing



Current Challenges

- Trade-offs among rate of cure, thickness, and catalyst.
- Multi-pass Printing

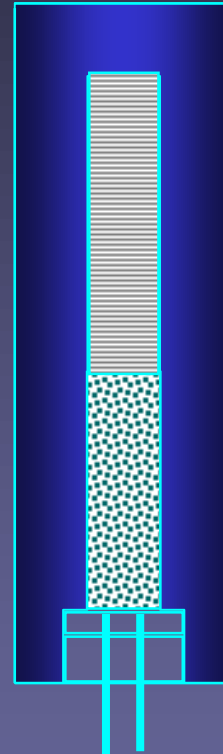
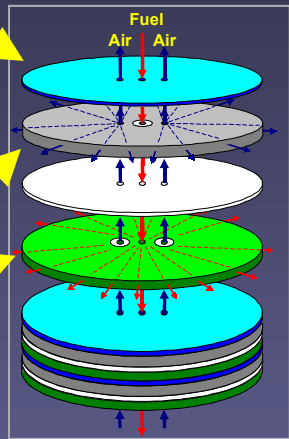


Low Cost Strategies

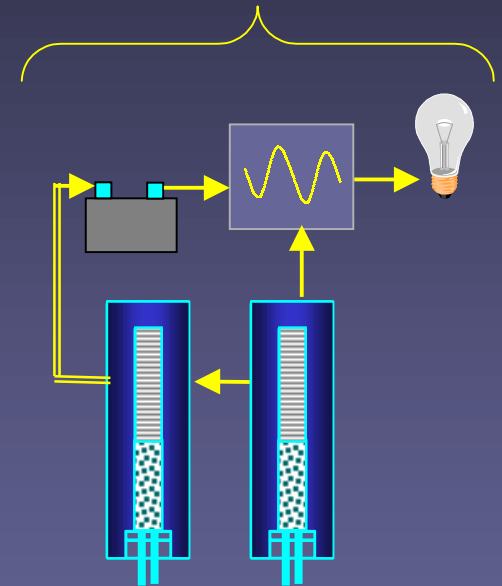
Integrated Hot Assembly (Internal)

Adv. Separators
DE-FG02-00ER83109

Multilayer Printing
"Manufacturing"
DE-AC26-00NT40707



Multi-Module Operation
DE-FC26-00NT41009



Summary

- Completed Cost Estimate.
- Identified Binders
 - Reactivity and Contamination Studies Initiated.
 - Trade-offs among rate of cure, thickness, and catalyst.
- Multi-pass tests (Phase III).